

General Description

The MAX5950 evaluation kit (EV kit) is a fully assembled and tested surface-mount circuit board featuring a PWM step-down DC-DC controller with integrated hot-swap capabilities for PCIe® ExpressModule™. The circuit board has an X8E PCIe ExpressModule form factor. The EV kit's circuit uses a MAX5950 and two MAX5951 ICs in 32-pin thin QFN packages. The MAX5950 EV kit provides outputs of 1.2V at 2.5A, and 2.5V and 3.3V with each providing 1.25A.

The MAX5950 EV kit demonstrates the MAX5950 IC's hot-swap inrush current control capabilities as well as the MAX5950 and MAX5951 ICs' hiccup-mode output short-circuit protection during normal operation. The MAX5950 controls an external n-channel MOSFET for inrush control during hot swapping. The EV kit can operate over an 8V to 16V input range, however, it is configured for 12V input operation by default. The MAX5950 EV kit also includes connections for the PCIe bus 3.3V auxiliary supply.

Additionally, the MAX5950 and MAX5951 PWM DC-DC step-down controllers' lossless current sensing, digital soft-start, startup synchronization, thermal shutdown, and hiccup-mode output short-circuit current-limit features can be evaluated using the EV kit. The VOUT1 circuit can also be reconfigured to evaluate an alternate current-sense method using a resistor for the DC-DC converter. The hot-swap and PWM undervoltage lockouts (UVLO) can easily be reconfigured for other set points. The MAX5950 EV kit can be reconfigured for various startup tracking/sequencing modes such as ratiometric-tracking, startup sequencing, PGOOD sequencing. The EV kit is configured for PGOOD sequencing by default.

To ease bench evaluation of the MAX5950 EV kit, a MAX5950PB power board assembly is included with the EV kit. The power board features bulk holdup capacitance for the 12V and 3.3V auxiliary power rails providing power to a single X8E PCIe connector. The power board includes switches, HC logic, and LEDs to simulate hot swapping a MAX5950 EV kit into a server's backplane utilizing an X8E PCIe connector.

The MAX5950 EV kit is not optimized for size, but is designed for ease of lab evaluation. See Appendix A, which shows a compact reference design with the same output voltages and currents. The reference design is configured for PGOOD sequencing.

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Features

- Demonstrates PCIe ExpressModule Hot-Swap and DC-DC Design
- **♦** Outputs

1.2V at 2.5A 2.5V at 1.25A

3.3V at 1.25A

- **♦ X8E PCIe ExpressModule Form Factor**
- **♦ Demonstrates Inrush Current Control and Lossless Current Sensing**
- **♦** Demonstrates Output Overcurrent/Short-Circuit **Protection**
- **♦ Configurable PWM and Hot-Swap UVLO**
- **♦** Configurable for Several Startup **Tracking/Sequencing Modes**
- ♦ Power Board Assembly Eases Bench Evaluation
- **♦ Surface-Mount Components**
- **♦ Fully Assembled and Tested**

Ordering Information

PART	TEMP RANGE	IC PACKAGE
MAX5950EVKIT	0°C to +70°C	32 TQFN-EP*

^{*}EP = Exposed paddle.

MAX5950 EV Kit Component List

DESIGNATION	QTY	DESCRIPTION	
C1	1	100µF ±20%, 6.3V X5R capacitor (1210) Murata GRM32ER60J107M	
C2	1	0.001µF ±10%, 50V X7R capacitor (0805) Murata GRM216R71H102K	
C3, C4	2	22μF ±10%, 16V X5R ceramic capacitors (1210) Murata GRM32ER61C226KE20	
C5, C8, C45, C48, C85, C88	6	1µF ±10%, 16V X7R ceramic capacitors (0805) Murata GRM21BR71C105K	
C6, C7, C46, C47, C86, C87	6	2.2µF ±10%, 10V X7R ceramic capacitors (0805) Murata GRM21BR71A225K	
C9	1	1000pF ±5%, 100V C0G ceramic capacitor (0805) Murata GRM2195C2A102J	

MAX5950 EV Kit Component List (continued)

DESIGNATION	QTY	DESCRIPTION	
C10, C11, C50, C90	4	22µF ±20%, 6.3V X5R capacitors (1206) Murata GRM31CR60J226ME19 ONLY use this specific capacitor	
C12	1	820pF ±5%, 50V C0G ceramic capacitor (0603) Murata GRM1885C1H821J	
C13, C53, C93	3	220pF ±10%, 50V X7R ceramic capacitors (0603) Murata GRM188R71H221K	
C14, C54, C94	3	0.033µF ±10%, 50V X7R ceramic capacitors (0603) Murata GRM188R71H333K	
C15, C49, C89	0	Not installed, ceramic capacitors (0805)	
C44, C84	2	10µF ±10%, 16V X5R capacitors (1206) Murata GRM31CR61C106KC31B ONLY use this specific capacitor	
C52, C92	2	1500pF ±10%, 50V X7R ceramic capacitors (0603) Murata GRM188R71H152K	
D1	1	Green, right-angle LED (T-1 3/4)	
D2	1	Yellow, right-angle LED (T-1 3/4)	
D3, D43, D83	3	Green surface-mount LEDs (1206)	
D4, D44, D84	3	300mA, 75V switching diodes (SOE 323) Diodes Inc 1N4148WS-F	
L1	1	1μH, 3.5A inductor Pulse PG0063.102NL	
L41	1	6.8µH, 1.5A inductor Pulse PG0063.682NL	
L81	1	10µH, 1.2A inductor Pulse PG0063.103NL	
N1	1	30V, 2.5A n-channel MOSFET (TSOP-6) Vishay Si3948DV-T1-E3	
N2	1	20V, 5.3A n-channel MOSFET (PowerPack 1212-8) Vishay Si7212DN-T1-E3	
N3, N43	2	20V, 1.9A n-channel MOSFETs (SC70-6) Fairchild FDG311N_NL	
N42, N82	2	20V, 3.1A n-channel MOSFETs (1206-8 chipFET) Vishay Si5904DC-T1-E3	
R1	1	7.5Ω ±5% resistor (1210)	
		1	

DESIGNATION	QTY	DESCRIPTION		
R2–R5, R21, R27, R30, R31, R33, R35, R36, R39, R44, R45, R50, R64, R67, R84, R85, R90, R104, R107	0	Not installed, resistors (0805)		
R6, R12	0	Not installed, resistors (0603)		
R7, R11	2	0Ω ±5% resistors (0603)		
R8, R48, R88	3	5.6Ω ±5% resistors (0805)		
R9, R49	2	910Ω ±5% resistors (0805)		
R10	1	10Ω ±5% resistor (0805)		
R13	0	Not installed, resistor (0805) 0.033Ω ±1%, 0.25W resistor Panasonic ERJL06KF33MV or IRC LRC-LR0805LF-01-R033-F recommended		
R14	1	576Ω ±1% resistor (0603)		
R15, R55, R95	3	10kΩ ±0.5% resistors (0805) Panasonic ERJ6RBD103V		
R16	1	20k Ω ±0.5% resistor (0805) Panasonic ERJ6RBD203V or Vishay TNPW-0805 20k Ω ±5% T-2RT1		
R18	1	5.23kΩ ±1% resistor (0805)		
R19, R59, R99	3	15k Ω ±1% resistors (0805)		
R20	1	2.15kΩ ±1% resistor (0805)		
R22	1	48.7kΩ ±1% resistor (0805)		
R23	1	49.9kΩ ±1% resistor (0805)		
R24, R28, R32, R34, R37, R38, R68, R108	8	0Ω ±5% resistors (0805)		
R25, R26, R89	3	110Ω ±5% resistors (0805)		
R54, R94	2	133Ω ±1% resistors (0805)		
R56	1	4.70kΩ ±0.5% resistor (0805) Vishay TNPW-0805 4.7kΩ ±0.5% T-9RT1 or Panasonic ERJ6RBD472V		
R57	1	10Ω ±1% resistor (0805)		
R58	1	27.4kΩ ±1% resistor (0805)		
R60, R100	2	3.83kΩ ±1% resistors (0805)		
R62, R102	2	34kΩ ±1% resistors (0805)		
R63, R103	2	59.0kΩ ±1% resistors (0805)		
R96	1	3.16kΩ ±0.5% resistor (0805)		

MAX5950EV Kit Component List (continued)

DESIGNATION	QTY	DESCRIPTION	
R97	1	39.2Ω ±1% resistor (0805)	
R98	1	40.2kΩ ±1% resistor (0805)	
VOUT1, VOUT2, VOUT3	3	PC test points, red	
PGND, PGND, PGND, PGND, PGND, GND1, GND2, GND3	8	PC test points, black	
PWREN, PWRFLT, MPWRGD, +12VIN, +12VHS	5	PC test points, miniature, red	
U1	1	MAX5950ETJ+ (32-pin TQFN, 5mm x 5mm) Package code: T3255-4	
U41, U81	2	MAX5951ETJ+ (32-pin TQFN, 5mm x 5mm) Package code: T3255-4	
_	1	MAX5950EVKIT circuit board assembly	
_	1	X8E PCIe Express power board assembly Maxim MAX5950PB	

⁺Denotes lead-free package.

Component Suppliers

SUPPLIER	PHONE	WEBSITE
Diodes Inc	805-446-4800	www.diodes.com
Fairchild	888-522-5372	www.fairchildsemi.com
IRC	361-992-7900	www.irctt.com
Molex Connector Corp	800-786-6539	www.molex.com
Murata	770-436-1300	www.murata.com
Panasonic	714-373-7366	www.panasonic.com
Pulse Engineering	858-674-8100	www.pulseeng.com
Sanyo Electronic Device	619-661-6835	www.sanyodevice.com
Vishay	_	www.vishay.com

Note: Indicate that you are using the MAX5950 when contacting these component suppliers.

MAX5950PB Power Board Assembly Component List

DESIGNATION	QTY	DESCRIPTION	
		150µF, 6.3V low-Z electrolytic	
C1	1	capacitor (6.3mm x 6mm case)	
		Sanyo 6.3CE150KX	
00.00.00	0	1μF ±10%, 16V X7R ceramic	
C2, C8, C9	3	capacitors (0805) Murata GRM21BR71C105K	
		680µF, 16V electrolytic capacitors	
C3-C7	5	(10mm x 10.2mm case)	
		Sanyo 16CE680KX	
D1, D2	2	Yellow surface-mount LEDs (1206)	
D3	1	Red surface-mount LED (1206)	
D4, D5	2	Green surface-mount LEDs (1206)	
		X8E PCIe Express connector	
J1	1	(140 pins)	
		Molex 48230-1015	
R1	1	62Ω ±5% resistor (0805)	
R2	1	510Ω ±5% resistor (0805)	
R3, R4	2	620Ω ±5% resistors (0805)	
R5	1	10kΩ ±5% resistor (0805)	
R6	1	150Ω ±5% resistor (0805)	
R7, R8	2	100kΩ ±5% resistors (0805)	
SW1, SW2, SW3	3	SPST slide switches	
+12V, PGND, PGND, +VAUX	4	Uninsulated banana jacks	
TP1-TP5, TP7	6	PC test points, miniature red	
TP6	1	PC test point, miniature black	
		HC quad 2-input AND gate	
U1	1	(14-SOP)	
		Texas Instruments SN74HC08NSR	
	4	X8E PCIe Express power board	
_	1	assembly (MAX5950PB)	
_	5	Rubber bumpers	

Quick Start

Required equipment:

- One each of the following DC power supplies 12V, 2A 3.3V, 1A
- One voltmeter

The MAX5950 EV kit is fully assembled and tested. Follow these steps to verify board operation. Do not turn on the power supply until all connections are completed.

Note: The banana leads connecting the 12V and 3.3V power supply to the EV kit must be short (< 24in long).

MAX5950 EV Kit and MAX5950PB Power Board Assembly Configuration

- 1) The MAX5950 EV kit is configured by default for PGOOD sequencing startup.
- 2) Set switches SW1, SW2, and SW3 to the OFF position on the MAX5950PB power board.

MAX5950PB Power Board Assembly Connections

- Utilizing short 5A-rated banana leads (< 24in long) connect the supply ground to the PGND banana jack. Utilizing short 5A-rated banana leads (< 24in long) connect the 12V DC power supply to the adjacent +12V banana jack.
- 2) Utilizing a short banana lead (< 24in long) connect the supply ground to the PGND banana jack. Utilizing a short banana lead (< 24in long) connect the 3.3V DC power supply to the adjacent +VAUX banana jack.
- 3) Test points TP1–TP5 and TP7 on the MAX5950PB power board are provided to observe various system hot-swap signals. TP6 is PGND.

Hot Swapping the MAX5950 EV Kit

- 1) Turn on the power supplies sourcing the MAX5950PB power board in any sequence.
- 2) Set switches SW1 (PWRLED), SW2 (ATNLED), and SW3 (PWREN) to the ON position.
- 3) Plug the MAX5950 EV kit into the MAX5950PB power board assembly.
- 4) Verify that the following green LEDs on the MAX5950 EV kit are as shown below.

VOUT1, D3 = ON VOUT2, D43 = ON VOUT3, D83 = ON

5) Verify that the voltage at the following pads and PGND on the MAX5950 EV kit are as shown below.

VOUT1 = 1.2V VOUT2 = 2.5V VOUT3 = 3.3V

6) Verify that the following LEDs on the MAX5950PB power board and EV kit are as shown below.

MAX5950PB power board: +12V, yellow D1 = ON +VAUX, yellow D2 = ON PWRFLT, red D3 = OFF MPWRGD, green D4 = ON PWREN, green D5 = ON MAX5950 EV kit: PWRLED, green D1 = ON ATNLED, yellow D2 = ON

- 7) Sliding switches SW1 and/or SW2 to the OFF position will disable the PWRLED and ATNLED on the MAX5950 EV kit. Also, sliding switches SW1 and SW3 to the ON position will turn on LED D5 on the power board assembly and the PWRLED and ATNLED on the MAX5950 EV kit.
- Sliding switch SW3 to the OFF position will disable the MAX5950 EV kit's outputs and reset all three DC-DC controllers on the MAX5950 EV kit.
- 9) Test points TP1-TP7 on the MAX5950 EV kit are provided to observe each MOSFET's gate voltage, respectively, with an oscilloscope.

See the *MAX5950PB Power Board Assembly* section for configuring and using the power board.

Detailed Description

The MAX5950 EV kit demonstrates a hot-swap and triple-output DC-DC converter circuit design on an X8E PCIe ExpressModule form-factor PC board. The EV kit is configured for 12V input operation by default, however, it can operate from an input range of 8V to 16V with suitable reconfiguration. The MAX5950 EV kit includes a passive PCIe Express 3.3V auxiliary supply bus. Resistor R1 limits the precharge current and time for the 3.3V auxiliary supply bus capacitor, C1.

A MAX5950 (U1) PWM step-down DC-DC controller with integrated hot-swap capabilities provides the hot-swapping control features and regulates the main output providing 1.2V at 2.5A. Two MAX5951 controllers (U41, U81) regulate the other outputs, providing 2.5V and 3.3V at 1.25A each.

The EV kit demonstrates the MAX5950 IC's hot-swap inrush current control, as well as hiccup-mode output short-circuit protection during normal operation. The MAX5950 drives a dual n-channel MOSFET (N1) while hot swapping and thus limits inrush current during the hot-swapping event. Inrush current is sensed across N1's drain-source resistance by the MAX5950, thus providing short-circuit protection after successful hot swapping. The current-sensing feature can be disabled by reconfiguring resistors R7 and R6. During a fault, the MAX5950 circuit breaker function latches the PWRFAULT pin to indicate a fault has occurred. To reset U1, cycle the input power or momentarily pull the PWREN pin high. The MAX5950 hot-swap UVLO threshold is set to 7V, however, other UVLO values can be evaluated by installing resistors R2 and R3.

Table 1. Startup Tracking/Sequencing Modes Configurations

MODE	OPEN RESISTORS	0Ω RESISTORS	CAPACITOR AND 1% RESISTORS TO BE CALCULATED
PGOOD Sequencing (default)	R21, R27, R30, R31, R33, R35, R36, R39, R67, R107	R28, R32, R34, R37, R68, R108	_
Ratiometric Tracking	R27, R32, R34, R39, R67, R107	R28, R30, R31, R33, R35–R38, R68, R108	_
STARTUP Sequencing	R32, R34	R30, R31, R33, R35-R39	C15, R22, R27, R28, R67, R68, R107, R108

The MAX5950 controller regulates the main output voltage at VOUT1 by driving MOSFETs N2A and N2B. Voltage-mode control is used along with feedback resistors R15 and R16 to set the voltage to 1.2V. RC network R14 to R16, R20, and C12 to C14 form the compensation network for this output. The MAX5950 switches at a 1MHz frequency and that is set by resistor R23. The SYNCOUT pin of U1 drives the SYNCIN pins of both MAX5951 controllers. The PWM UVLO threshold is set to 7V, however, other UVLO settings can be evaluated by installing resistors R4 and R5.

Separate MAX5951 controllers regulate the two other outputs, VOUT2 and VOUT3. IC U41, a MAX5951, drives MOSFETs N42A and N42B and utilizes voltage-mode control along with feedback resistors R55, R56, and R57 to set VOUT2 at 2.5V. RC network R54–R57, R60, and C52 to C54 form the compensation network for this output. IC U81, a MAX5951, drives MOSFETs N82A and N82B and utilizes voltage-mode control along with feedback resistors R95, R96, and R97 to set VOUT3 at 3.3V. RC network R94, R100, and C92 to C94 form the compensation network for this output.

The VOUT2 and VOUT3 converters switch at 1MHz and are driven by the SYNCOUT pin of U1. Both U41 and U81 switch 180 degrees out-of-phase with respect to U1. Each converter's PWM UVLO is set by a resistor-divider. To evaluate a specific PWM UVLO different than the default, select and install the required resistors.

All three outputs are configured for lossless valley current sensing by default. However, output 1 can be reconfigured to use a current-sense resistor. See the *Current-Limiting (ILIM)* section for reconfiguring the current-sensing method. The MAX5950 EV kit demonstrates all three output's respective controllers' digital soft-start, thermal shutdown, and hiccup-mode output short-circuit current-limit features.

The MAX5950 EV kit is configured for PGOOD sequencing by default. The EV kit can also be reconfigured for ratiometric tracking or startup sequencing. See the *Startup Tracking/Sequencing Modes* for reconfiguring the startup mode.

The MAX5950 EV kit features a green PWRLED LED and yellow ATNLED LED to indicate connectivity when the EV kit is currently powered. Red test points are included for probing various signals. All of the EV kit's black test points are PGND or GND points.

The EV kit includes an X8E PCIe power board (MAX5950PB) assembly that includes bulk-holdup capacitance for the PCIe 12V and 3.3V auxiliary power rails. The MAX5950PB provides power to a single X8E PCIe connector, J1. The power board assembly includes three switches, HC logic, and LEDs that facilitate the simulation of hot swapping a MAX5950 EV kit into a server's backplane. See the MAX5950PB Power Board Assembly section for more information on the MAX5950PB assembly.

EV Kit Reconfiguration

The following table displays the various configurable functions provided by the MAX5950 and MAX5951 ICs used on the MAX5950 EV kit. Information on component replacement or removal is provided.

Startup Tracking/Sequencing Modes

The MAX5950 EV kit is configured for PGOOD sequencing by default. The EV kit can be reconfigured for one of three startup tracking/sequencing modes such as ratiometric tracking, startup sequencing, or PGOOD sequencing. To reconfigure the EV kit for another mode, install or remove the appropriate surface-mount (0805 case) resistor and/or capacitor as detailed in Table 1.

Chart 1 illustrates the required connections for the three startup modes: tracking, startup sequencing, and PGOOD sequencing.

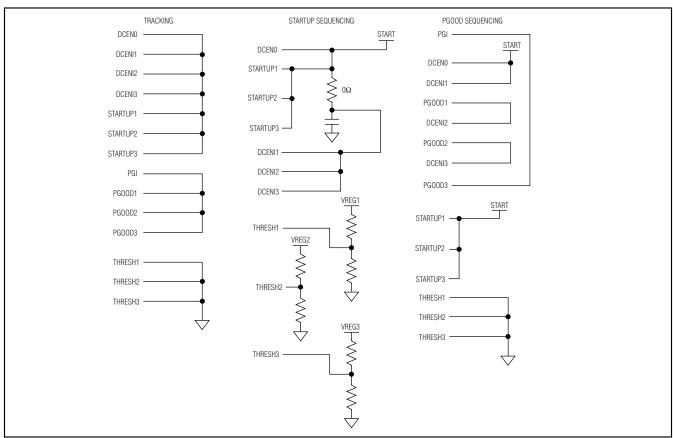


Chart 1. Startup Modes Connections

Hot-Swap Controls and Other DC-DC Converter Configurations

Hot-Swap UVLO Configuration (HUVLO)

The MAX5950 hot-swap UVLO is configured for 7V (typ) on the rising +12VIN input voltage by default. Other hot-swap UVLOs can be evaluated by selecting and installing resistors R2 and R3 (0805 case). Using the desired startup voltage, calculate the resistor R2 value using the following equation:

$$R2 = \left(\frac{VIN_{STARTUP}}{1.22V} - 1\right) \times R3$$

where VINSTARTUP is the desired hot-swap startup voltage (\geq 7V) and resistor R3 is typically 10k Ω . Refer to the MAX5950 data sheet for additional information on the HUVLO pin.

Hot-Swap Sense Input Configuration (HSENSE)

The MAX5950 monitors input current by sensing the voltage across MOSFET N1. Once the MOSFET is fully enhanced after hot swapping, the MAX5950 circuit breaker function is enabled. To disable sensing input current, remove resistor R7 and install a 0Ω , 0805, surface-mount resistor at the R6 resistor pads.

PWM UVLO Configuration (PUVLO)

The MAX5950 and MAX5951 PWM UVLOs are configured for 7V (typ) on the rising 12VHS input voltage. Other PWM UVLOs can be evaluated by selecting and installing resistors R4 and R5 for U1, resistors R44 and R45 for U41, or resistors R84 and R85 for U81 (0805 case). Using the desired startup voltage, calculate the appropriate resistor value using the following equation:

R4, R44, R84 =
$$\left(\frac{VIN_{STARTUP}}{1.22V} - 1\right) \times 10k\Omega$$

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Table 2. Current-Limiting Reconfiguration

IC	SENSE RESISTOR	RESISTORS	ILIM RESISTORS	EV KIT FUNCTION
U1	R13 = PC trace short	R11 = 0Ω R12 = Open	R21 = Open R22 = $5k\Omega$	Lossless current sensing
01	R13 = Cut open trace shorting pads, calculate	R11 = Open R12 = 0Ω	R21 = Calculate R22 = 48.7 k Ω	Alternate inductor valley current sensing

where VINSTARTUP is the desired converter startup voltage (\geq 7V) and resistors R5, R45, and R85 are 10k Ω . Refer to the MAX5950 data sheet for additional information on the MAX5950 and MAX5951 PUVLO pin.

DC-DC Enable Input Configuration (THRESH)

The MAX5950 and MAX5951 DC-DC enable THRESH inputs are configured for 1.22V by default, and the respective converter starts when its DCENI input is greater than 1.22V. To evaluate other DCENI startup voltages, set the THRESH voltage using the equation below. Reconfigure the respective controller by installing the recommended 0805 surface-mount 1% resistors at the designated resistor PC board pads. Refer to the MAX5950 data sheet for additional information on the MAX5950 and MAX5951 IC's THRESH pin.

R27, R67, or R107 =
$$\left(\frac{5V}{V_{THRESH}} - 1\right) \times 10k\Omega$$

where V_{THRESH} is between 0.6V and 2.5V.

Output Voltage Sensing (SENSE)

The MAX5950 and MAX5951 controllers monitor the respective output voltages to determine if the output power is good. Resistors R18 and R19 for U1, resistors R58 and R59 for U41, and resistors R98 and R99 (0805 case) for U81 are selected to provide a PGOOD trip voltage that is 90% of the typical output voltage. To evaluate other PGOOD trip voltages, use the following equation:

R18, R58, R98 =
$$\left(\frac{V_{PGTH}}{0.8V} - 1\right) \times 10k\Omega$$

R19, R59, R99 = $10k\Omega$

where V_{PGTH} is the desired power-good threshold voltage. Resistors R19, R59, and R99 are typically 10k Ω . Refer to the MAX5950 data sheet for additional information on the MAX5950 and MAX5951 SENSE pins.

Current-Limiting (ILIM)

All three outputs on the MAX5950 EV kit are configured for lossless valley current sensing by default. Refer to the MAX5950 IC data sheet for more information on how lossless valley current limiting functions and how to set the required ILIM resistors, R22, R62, and R102. Alternatively, output 1 can be independently reconfigured to use a current-sense resistor. To reconfigure the current-sensing method, see Table 2; use the equations below for selecting the current-sense resistor.

The MAX5950 controller turns off the switching MOSFET (N2-A) for the subsequent switching cycle if the voltage difference at CS+ and CS- reached 100mV during the off-time for more than 8 sequential clock cycles, the controller will go into hiccup mode. Current-sense resistor R13 sets the valley current limit when using this mode of current sensing. To evaluate other current limits, current-sense resistor R13 must be replaced with a surface-mount resistor (1210 size) as determined by the following equation:

where Vcs = VILIM/10, IOUTMAX = maximum DC output current (2.5A as configured).

When using a current-sense resistor, use R21 and R22 to set the ILIM threshold voltage. Use the following equation to configure the desired ILIM threshold voltage.

$$R21 = \left(\frac{V_{REG} \times 10}{V_{ILIM}} - 1\right) \times R22$$

where V_{REG} = 5V, V_{ILIM} is in the range of 0.5V to 3.5V, and R22 is $5k\Omega$.

Refer to the MAX5950 data sheet for additional information on the MAX5950 controller current-sensing capabilities.

MAX5950PB Power Board Assembly X8E PCle Power Board Assembly

The MAX5950PB PCIe power board assembly includes bulk-holdup capacitance for the PCIe 12V and 3.3V auxiliary power rails. Connect a 12V, 2A minimum rated power supply to the +12V and adjacent PGND banana jacks or pads. Connect a 3.3V, 1A minimum rated power supply to the +VAUX and adjacent PGND banana jacks or pads. Yellow LEDs D1 and D2 on the power board indicate when power is applied and assist discharging the respective bulk-holdup capacitance. The MAX5950PB provides power to a single X8E PCIe connector, J1.

The MAX5950PB includes three switches, HC logic, and LEDs that facilitate the simulation of hot swapping

a MAX5950 EV kit into a server's backplane. Slide switch SW1 controls the PWRLED signal and SW2 controls the ATNLED signal. SW3 is used to enable/disable or reset the MAX5950 controller, thus enabling and disabling the MAX5950 EV kit outputs.

Red LED D3 indicates when a PWRFLT signal is activated and/or the green LED D4 indicates when a MPWRGD signal is activated by the MAX5950 controller. The green LED D5 indicates when a PRSNT and ATNLED signal are present, thus simulating a system slot interface signal.

See the *Quick Start* section for additional information on configuring and using the MAX5950PB power board assembly.

PCI-Express-X8E Hot-Swap DC-DC Converters

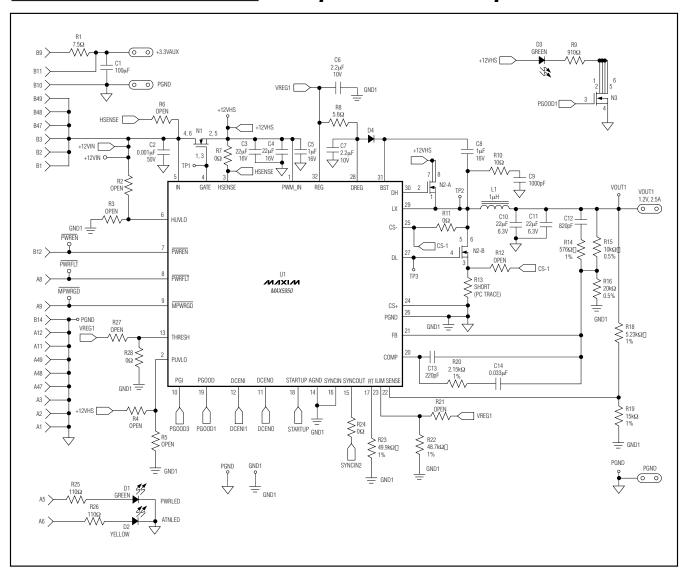


Figure 1. MAX5950 EV Kit Schematic—Hot-Swap and VOUT1 Circuits

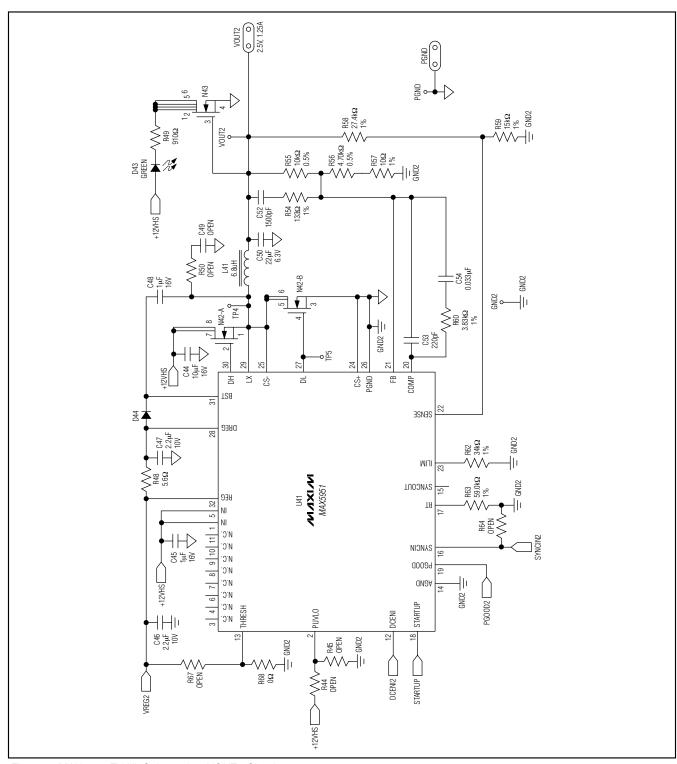


Figure 2. MAX5950 EV Kit Schematic—VOUT2 Circuit

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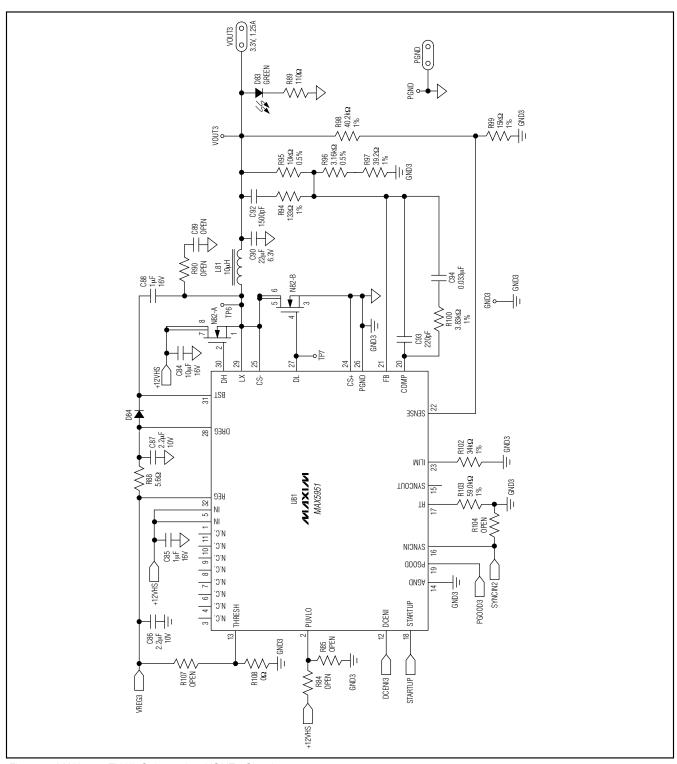


Figure 3. MAX5950 EV Kit Schematic—VOUT3 Circuit

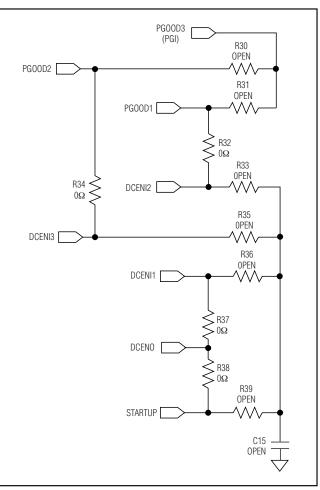


Figure 4. MAX5950 EV Kit Schematic—Tracking Sequencing Configuration Circuit

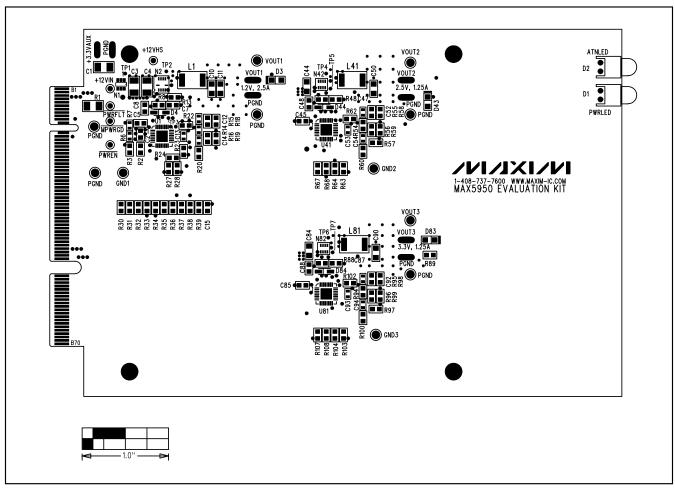


Figure 5. MAX5950 EV Kit Component Placement Guide—Component Side

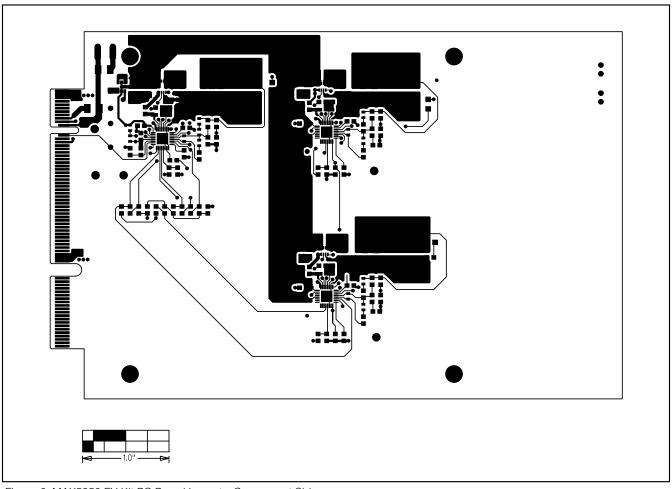


Figure 6. MAX5950 EV Kit PC Board Layout—Component Side

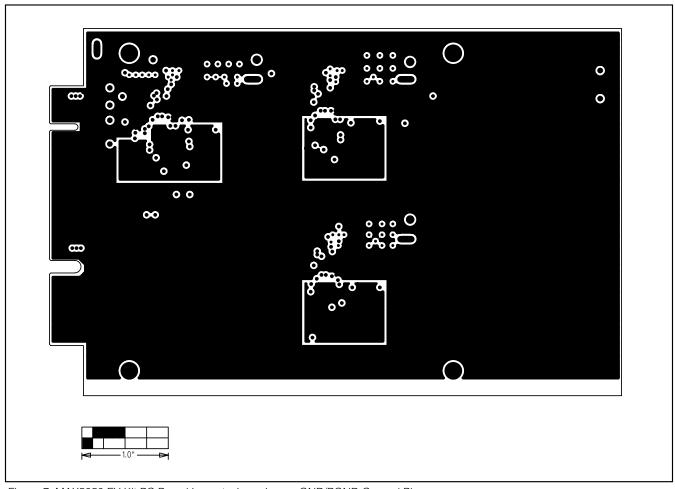


Figure 7. MAX5950 EV Kit PC Board Layout—Inner Layer, GND/PGND Ground Plane

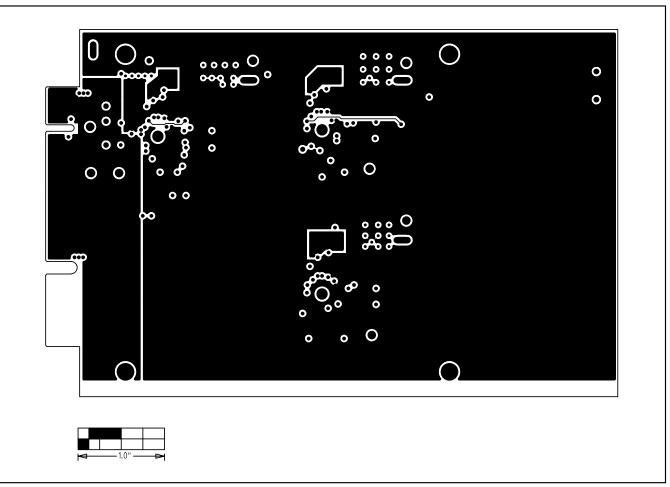


Figure 8. MAX5950 EV Kit PC Board Layout—Inner Layer, VCC/PGND Power Plane

16 _______/II/XI/M

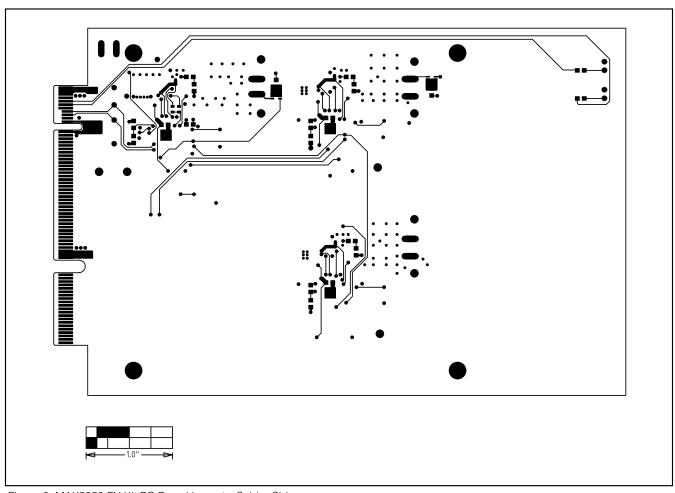


Figure 9. MAX5950 EV Kit PC Board Layout—Solder Side

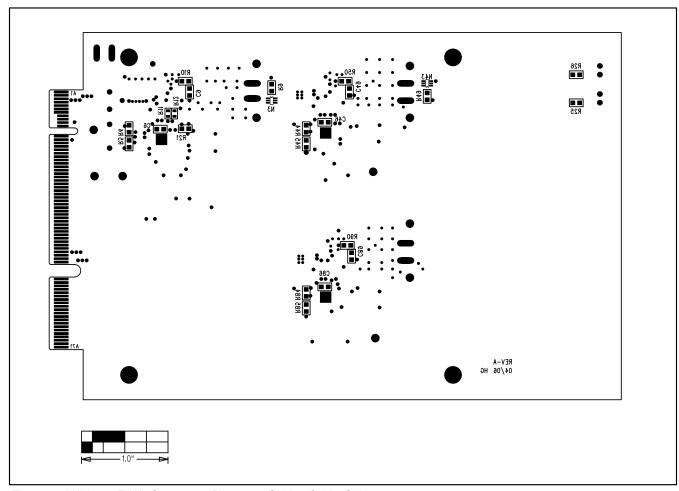


Figure 10. MAX5950 EV Kit Component Placement Guide—Solder Side

MAX5950PB Power Board Assembly

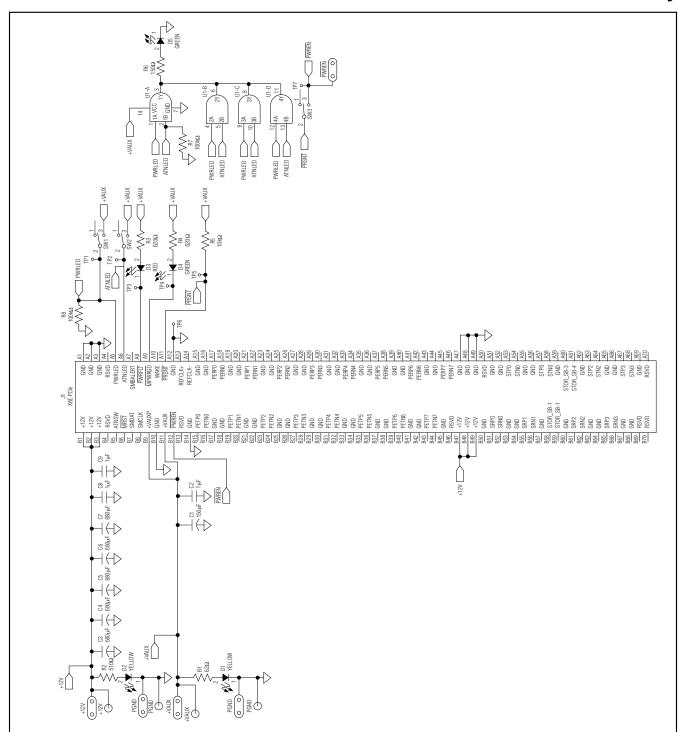


Figure 11. MAX5950PB Schematic

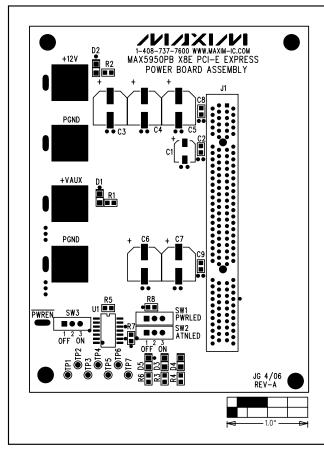


Figure 12. MAX5950PB Component Placement Guide—Component Side

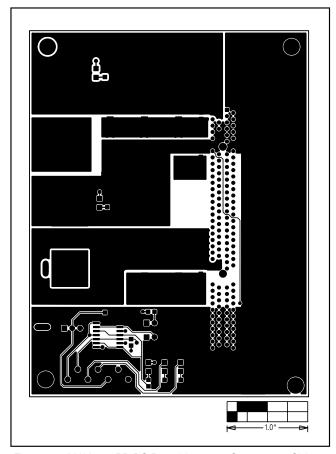


Figure 13. MAX5950PB PC Board Layout—Component Side

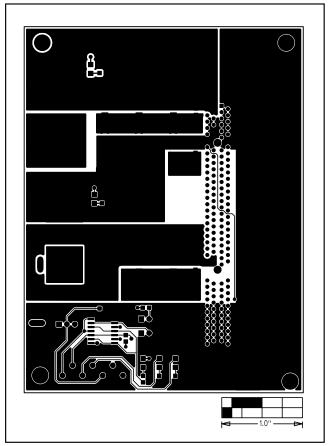


Figure 14. MAX5950PB PC Board Layout—Solder Side

_Appendix A

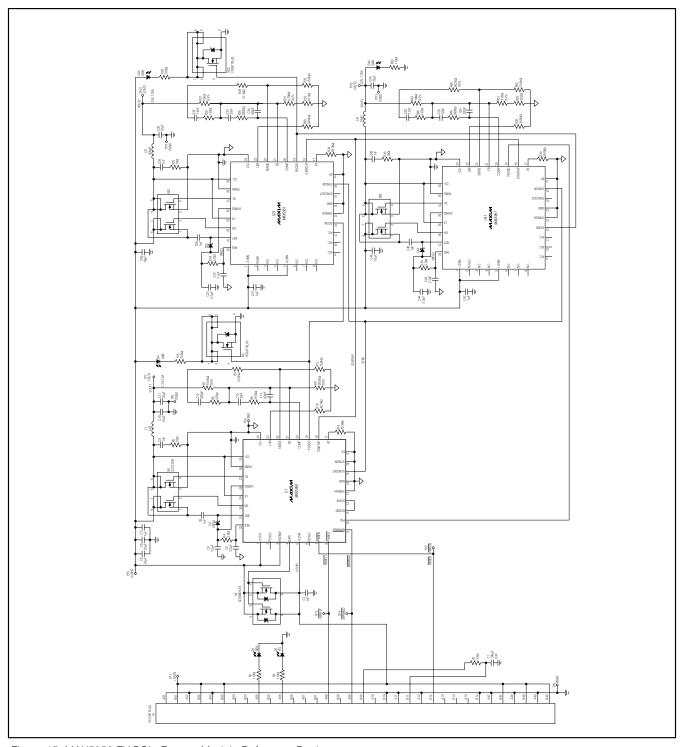


Figure 15. MAX5950 EV PCIe ExpressModule Reference Design

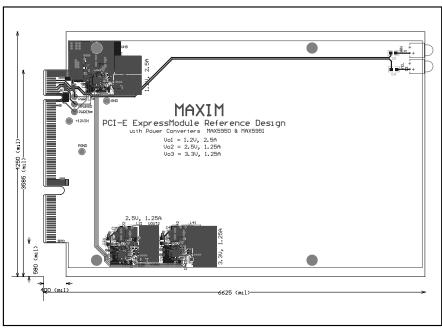


Figure 16. MAX5950 EV PCIe ExpressModule Reference Design—Composite View

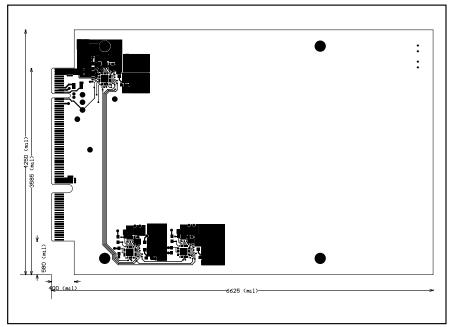


Figure 17. MAX5950 EV PCIe ExpressModule Reference Design—Top Layer

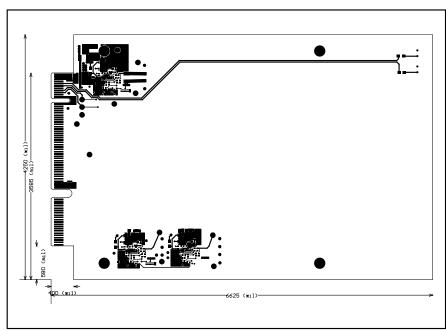


Figure 18. MAX5950 EV PCIe ExpressModule Reference Design—Bottom Layer

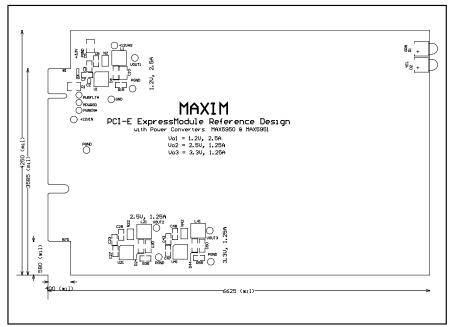


Figure 19. MAX5950 EV PCIe ExpressModule Reference Design—Top Silkscreen

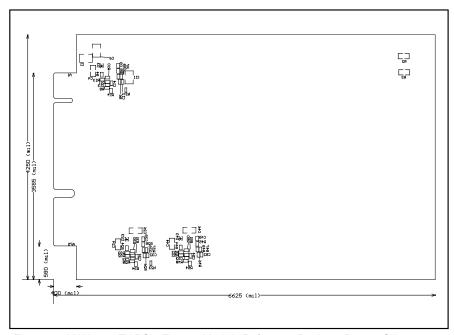


Figure 20. MAX5950 EV PCIe ExpressModule Reference Design—Bottom Silkscreen

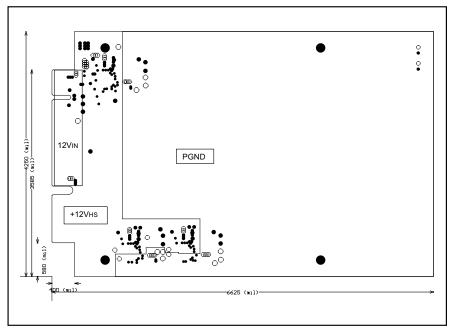


Figure 17. MAX5950 EV PCIe ExpressModule Reference Design—Inner 12VIN-12VHS-PGND Layer

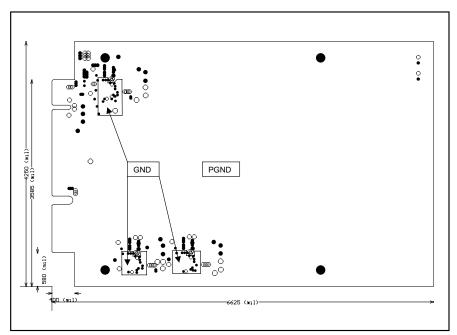


Figure 22. MAX5950 EV PCIe ExpressModule Reference Design—Inner GND-PGND Laver